

## High-Performance Heating Elements

**CNT Films on Thin and Flexible Substrates** 





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## **Overview**

- collaboration between applied research and industry
- how runs such a project
- ideas
- reality
- project  $\rightarrow$  it is always a compromise







## Why a new type of heating elements?

#### Motivation/benefits

- industrial partner → need for innovation
- saving production costs → building-up a own production
- less metal and simple building → saving of space and weight
- energy saving
- environmental protection





## **Requirements and specifications**

- thin film/coating
- Iow heat capacity
- homogeneous heat distribution
- substrates mica (unique electrical and thermal insulating properties, low cost for mass production)
- power supply 230 V
- operating temperature 100 to 150 °C
- short-term temperature stress 250 °C



## **Dispersion and film production**

#### part of Fraunhofer IPA:

- development of CNT dispersion
- production of thin CNT films
- adhesion properties on substrate
- electrical and thermal properties











## Dispersion

- carbon nanotubes (CNTs)  $\rightarrow$  C150P (Baytubes)
- water based dispersion
- additives
  - gum Arabicum as dispersant
  - ethanol to minimize the surface tension
- dispersion quality → quantity, distribution and particle size of CNTs in the dispersion











## **CNT dispersion**

#### incorporation of CNTs in the dispersion





## **CNT dispersion**

#### • particle size and distribution

			Diam. (nm)	% Intensity	Width (nm)
Z-Average (d.nm):	220	Peak 1:	305	73.3	101
PdI:	0.362	Peak 2:	113	21.9	23.8
Intercept:	0.870	Peak 3:	5290	4.8	652





### **Substrates**

- mica (mica plates)
  - electrically insulating
  - stable for thermal and heating capacity up to 350 °C or 3,5 W/cm<sup>2</sup>
  - low cost for mass production
- CNT film production
  - spray coating
  - good wetting of the surface
  - low adhesion → exfoliation of the mica sheets







### **Substrates**

- polyimide film (kapton developed by DuPont)
  - electrically insulating
  - thermal stable up to 400 °C
  - flexible
- CNT film production
  - spray coating
  - good wetting of the surface
  - very good adhesion
  - coating thickness 9 to 10 μm
  - sheet resistance ~ 40 Ω/sq







polyimide film on mica and aluminum plates







- for the first coating tests polyimide film was applied on mica and aluminum plates
- non-homogeneous temperature/heat distribution
- low adhesion of polyimide film to mica plate → adhesive is not temperature stable









- dimension of the samples
  50 x 100 mm<sup>2</sup>
- power supply 35 V
- ambient temperature
- cooled with fan



number of cycles	heating	cooling	temperature
0 to 3385	1 min	12 s	ca. 90°C
3386 to 7691	2 min	12 s	ca. 100°C
7692 to13167	3 min	18 s	ca. 110°C



- lifetime tests → up to 13000 cycles
- acceptable resistance change
- homogeneous temperature/heat distribution



sample number	cold resistivity	after 3385 cycles	change from the beginning	after 7691 cycles	change from the beginning	after 13167 cycles	change from the beginning	
6	92 Ohm	87 Ohm	-5,40%	87 Ohm	-5,40%	-	-	
10	103 Ohm	100 Ohm	-2,90%	100 Ohm	-2,90%	99 Ohm	-3,90%	
11	107 Ohm	104 Ohm	-2,80%	104 Ohm	-2,80%	-	-	
12	110 Ohm	105 Ohm	-4,50%	105 Ohm	-4,50%	107 Ohm	-2,70%	
17	91 Ohm	90 Ohm	-1,10%	90 Ohm	-1,10%	90 Ohm	-1,10%	
18	84 Ohm	80 Ohm	-4,80%	81 Ohm	-3,60%	92 Ohm	9,50%	





 dimension of the sample – 108 x 48 mm<sup>2</sup>



#### heating element - CNT coating on polyimide foil - 90 V (~1 W/cm<sup>2</sup>)





### Experiments

• CNT film on mica plate in air and oil





### **Experiments**

- CNT film on polyimide, glued on mica plate, in oil
- dimension of the sample – 100 x 50 mm<sup>2</sup>
- 300 V; 4,7 A
  - $\rightarrow$  1400 W
  - $\rightarrow$  28 W/cm<sup>2</sup>





## Outlook

#### insulating

- $\rightarrow$  electrically for voltage > 48 V
- $\rightarrow$  oxidation of the CNT film for temperature > 250 °C
- contacting of samples
- film thickness controlled by spray coating
- reduce the electrical conductivity for 230 V
- concepts for mass production implemetation in the application



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